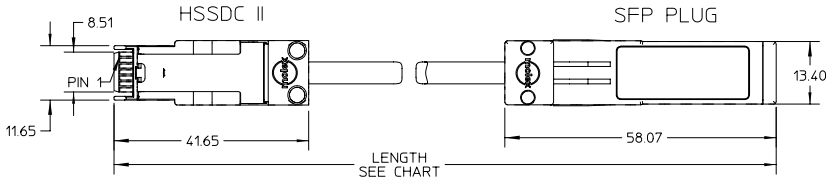
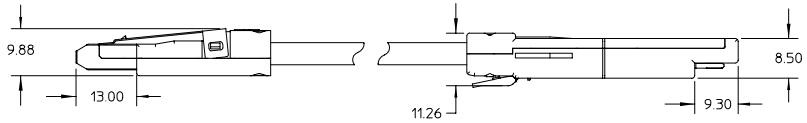
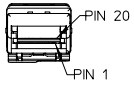
73929

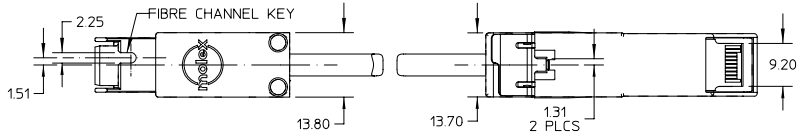
WIRING DIAGRAM			
SFP		HSSDC II	
PIN	SIGNAL	PIN	SIGNAL
19	Tx-	2	Rx-
18	Tx+	3	Rx+
13	Rx+	5	Tx+
12	Rx-	6	Tx-











SFP NOTES:
1. MATERIALS
   BACKSHELLS - NICKEL PLATED ZINC
   LATCH - GLASS FILLED POLYCARBONATE
   PCB - FR-4
   RIVETS -TIN PLATED STEEL
2. IMPEDANCE MATCHING SFP (100 OHMS) TO HSSDC II (150 OHMS)

HSSDC II NOTES:
1. MATERIALS
   BACKSHELLS - NICKEL PLATED ZINC
   LATCH - TIN PLATED PHOS BRONZE
   PCB - FR-4
   RIVETS -TIN PLATED STEEL
2. CHARACTERISTIC IMPEDANCE 150 OHMS DIFFERENTIAL

CABLE NOTES:
1. CHARACTERISTIC IMPEDANCE 150 ± 10 OHMS MEASURED DIFFERENTAL
2. SEE MOLEX DRAWINGS SD-71153-7*** FOR FURTHER CABLE DETAILS

PART NUMBER	LENGTH
73929-4001	1 M ± 0.05 M
73929-4002	3 M ± 0.07 M
73929-4003	5 M ± 0.08 M
73929-4005	2 M ± 0.06 M
73929-4006	4 M ± 0.07 M

EC NO: UDT 2002-08803
DRWN: DSLEWIS 2002/03/08
CHK: DDOYE 2002/02/12
APPR: DDOYE 2002/02/14
DESCRIPTION
REV A

QUALITY SYMBOLS
▼ - 0
Ⓒ - 0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± 0.25	± ---
1 PLACE	± 0.3	± ---
ANGULAR	± 2 °	

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

SCALE 1:1 | DESIGN UNITS METRIC | THIRD ANGLE PROJECTION | REVISE ON CAD ONLY

DIMENSION STYLE: MM ONLY

DRAWN BY: DSL DATE: 2001/12/05
CHECKED BY: DLD DATE: 2001/12/06
APPROVED BY: DLD DATE: 2001/12/06

TITLE
SFP TO HSSDC II
PATCH CABLE ASSEMBLY
FIBRE CHANNEL 150 OHMS

molex MOLEX INCORPORATED

MATERIAL NO. 739294002
DOCUMENT NO. SD-73929-400
SHEET NO. 1 OF 1

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